Docket No.: 29137.074.00 Application Filed July 12, 2005

Application No.: Not Yet Assigned

Preliminary Amendment filed July 12, 2005

AMENDMENT TO THE CLAIMS

Please amend the claims as follows:

1. Organic siloxane resins, which are condensed polymers, (Original)

manufactured by a hydrolysis and condensation reaction of silane compounds comprising one or

more kinds of hydrosilane compounds under a base catalyst.

2. (Original) The organic siloxane resins according to Claim 1, wherein said

silane compounds are comprised of hydrosilane compounds entirely, or of hydrosilane

compounds and organic silane compounds other than said hydrosilane compounds.

3. (Currently Amended) The organic siloxane resins according to Claim 2, wherein

saidhydrosilane said hydrosilane compounds are silane compounds having a chemical formula

represented by the following Chemical Formula 1, oligomers manufactured from said silane

compounds in said Chemical Formula 1, oligomers manufactured from said silane compounds in

said Chemical Formula 1, or cyclic siloxane compounds having a chemical formula represented

by the following Chemical Formula 2:

[Chemical Formula 1]

H_nSiR¹_{4-n}

where R¹ is independently fluorine, aryl, vinyl, allyl, or linear or branched C1~4 alkyl

substituted or unsubstituted with fluorine, or alkoxy; and n is an integer of 1 to 3; and

[Chemical Formula 2]

 $H_k \square_{SiO_I} (R^2)_{2I-k}$

Application Filed July 12, 2005 Docket No.: 29137.074.00

Application No.: Not Yet Assigned

Preliminary Amendment filed July 12, 2005

where R² is independently fluorine, aryl, vinyl, allyl, or linear or branched C1~4 alkyl substituted or unsubstituted with fluorine, or alkoxy; and k and l are integers of 3 to 10.

4. (Original) The organic silane resins according to Claim 2, wherein said

organic silane compounds other than said hydrosilane compounds are silane compounds having a

chemical formula represented by the following Chemical Formula 3 or 4:

[Chemical Formula 3]

$$SiR_{p}^{3}R_{4-p}^{4}$$

where R³ is independently fluorine, aryl, vinyl, allyl, or linear or branched C1~4 alkyl substituted or unsubstituted with fluorine; R⁴ is independently acetoxy, hydroxy, or linear or branched C1~4 alkoxy; and p is an integer of 0 to 3; and

[Chemical Formula 4]

$${R^5}_q {R^6}_{3\text{-}q} Si\text{-}M\text{-}Si{R^7}_r {R^8}_{3\text{-}r}$$

where R⁵ and R⁷ are independently fluorine, aryl, vinyl, ally, or linear or branched C1~4 alkyl substituted or unsubstituted with fluorine; R⁶ and R⁸ are independently acetoxy, hydroxy, or linear or branched C1~4 alkoxy; M is alkylene or phenylene having 1 to 6 carbon atoms; and q and r are integers of 0 to 3.

- 5. (Currently Amended) Compositions for forming insulating films comprising said organic siloxane resins manufactured according to any of Claims 1 through 4 Claim 1.
- 6. (Original) A method of forming insulating films using organic siloxane resins comprising the steps of:
 - a) preparing an organic siloxane resin;

Application Filed July 12, 2005 Docket No.: 29137.074.00

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Preliminary Amendment filed July 12, 2005

b) dissolving the organic siloxane resin in an organic solvent;

c) forming an insulating film by coating a solution, which is prepared by dissolving the

above organic siloxane resin in organic solvent; and

d) drying and hardening the insulating film formed in the above.

7. (Original) The method of forming a insulating film using said organic

siloxane resins according to Claim 6, further comprising a step, after the above step b), of adding

one or more kinds of additives selected from the group consisting of organic molecules, organic

polymers, organic dendrimers, water, pH controlling agents, colloidal silica, and surfactants to

said solution.

8. (Currently Amended) Insulation films using organic siloxane resins manufactured

by drying and hardening insulating films formed by coating the solution, which is prepared by

dissolving said organic siloxane resins according to any of Claims Claim 1 to 4 in an organic

solvent, onto a substrate.

9. (Currently Amended) Electronic devices comprising insulating films using

organic siloxane resins manufactured by drying and hardening of insulating films formed by

coating the solution, which is prepared by dissolving said organic siloxane resins according to

any of Claims 1 to 4 Claim 1 in an organic solvent, onto a substrate

Page 5 of 6

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